



## Thyristor Modules

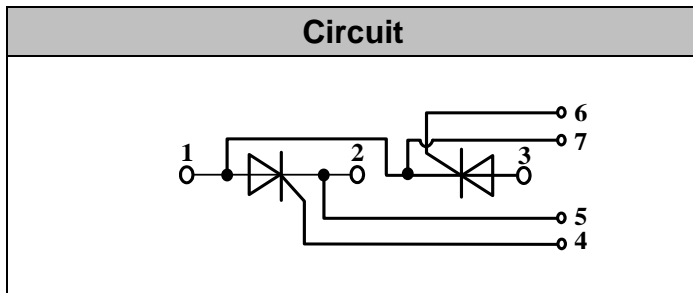
**VRRM / VDRM** 800 to 1800V  
**ITAV** 200A

### Applications

- Power Converters
- Lighting Control
- DC Motor Control and Drives
- Heat and temperature control

### Features

- International standard package
- High Surge Capability
- Glass passivated chip
- Simple Mounting
- Heat transfer through aluminum oxide DBC ceramic isolated metal baseplate
- UL recognized applied for file no. E360040



### Module Type

TYPE	VRRM	VRSM
MT200C08SCT2	800V	900V
MT200C12SCT2	1200V	1300V
MT200C16SCT2	1600V	1700V
MT200C18SCT2	1800V	1900V

### Maximum Ratings

Symbol	Conditions	Values	Units
ITAV	Sine 180°; Tc=85°C	200	A
ITSM	Tvj=45°C t=10ms, sine	7300	A
	Tvj=125°C t=10ms, sine	7000	
i²t	Tvj=45°C t=10ms, sine	191000	A²s
	Tvj=125°C t=10ms, sine	155000	
Visol	a.c.50HZ;r.m.s.;1min	3000	V
Tvj		-40 to 130	°C
Tstg		-40 to 125	°C
Mt	To terminals(M6)	5 ± 15%	Nm
Ms	To heat sink(M6)	5 ± 15%	Nm
di/dt	Tvj= TvJM , 2/3VDRM , Ig =500mA Tr<0.5us,tp>6us	200	A/us
dv/dt	Tj= TvJM ,2/3VDRM, linear voltage rise	1000	V/us
a	Maximum allowable acceleration	50	m/s²
Weight	Module(Approximately)	160	g

### Thermal Characteristics

Symbol	Conditions	Values	Units
Rth(j-c)	per thyristor / per module	0.14/0.08	°C/W
Rth(c-s)	per thyristor / per module	0.07/0.05	°C/W

## Electrical Characteristics

Symbol	Conditions	Values			Units
		Min.	Typ.	Max.	
$V_{TM}$	$T=25^{\circ}C$ $I_{TM}=500A$			1.68	V
$I_{RRM}/I_{DRM}$	$T_{VJ}=T_{VJM}$ , $V_R=V_{RRM}$ , $V_D=V_{DRM}$			50	mA
$V_{TO}$	For power-loss calculations only ( $T_{VJ}=125^{\circ}C$ )			0.85	V
$r_T$	$T_{VJ}=T_{VJM}$			1.5	m $\Omega$
$V_{GT}$	$T_{VJ}=25^{\circ}C$ , $V_D=6V$			3	V
$I_{GT}$	$T_{VJ}=25^{\circ}C$ , $V_D=6V$			200	mA
$V_{GD}$	$T_{VJ}=125^{\circ}C$ , $V_D=2/3V_{DRM}$			0.25	V
$I_{GD}$	$T_{VJ}=125^{\circ}C$ , $V_D=2/3V_{DRM}$			10	mA
$I_L$	$T_{VJ}=25^{\circ}C$ , $R_G=33\ \Omega$		300	1000	mA
$I_H$	$T_{VJ}=25^{\circ}C$ , $V_D=6V$		150	400	mA
tg $d$	$T_{VJ}=25^{\circ}C$ , $I_G=1A$ , $di_G/dt=1A/us$		1		us
tq	$T_{VJ}=T_{VJM}$		100		us

Performance Curves

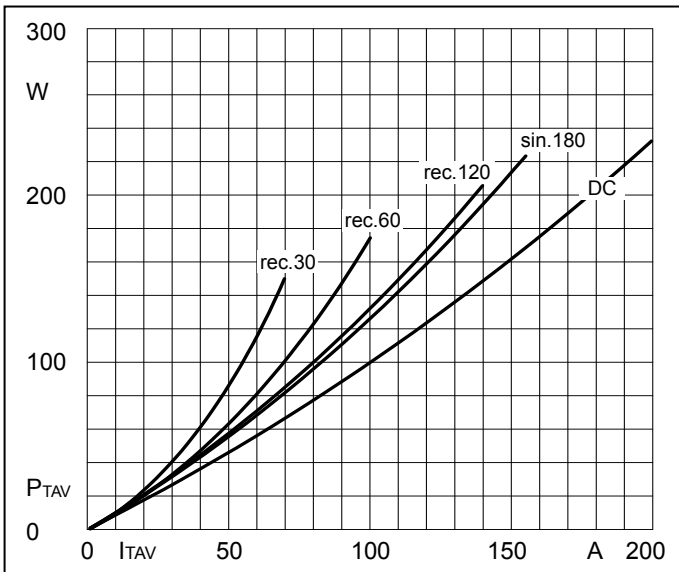


Fig1. Power dissipation

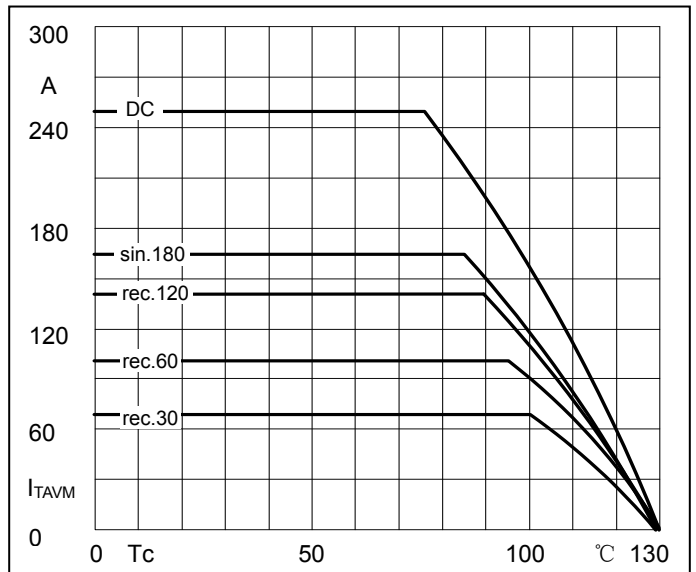


Fig2. Forward Current Derating Curve

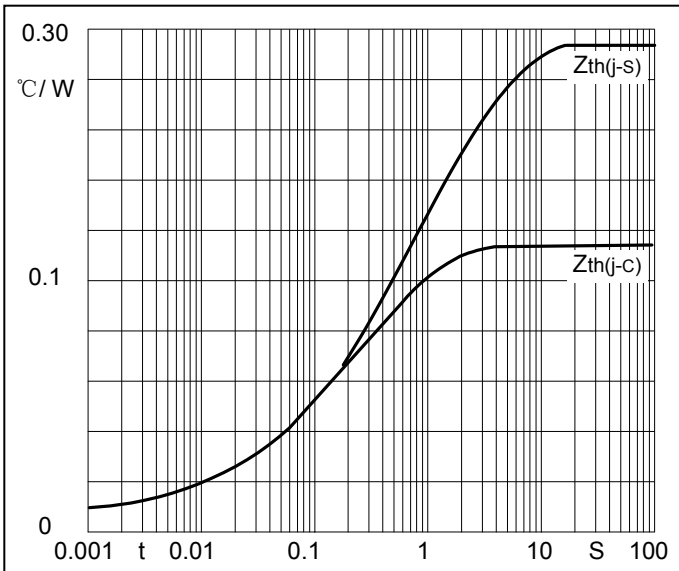


Fig3. Transient thermal impedance

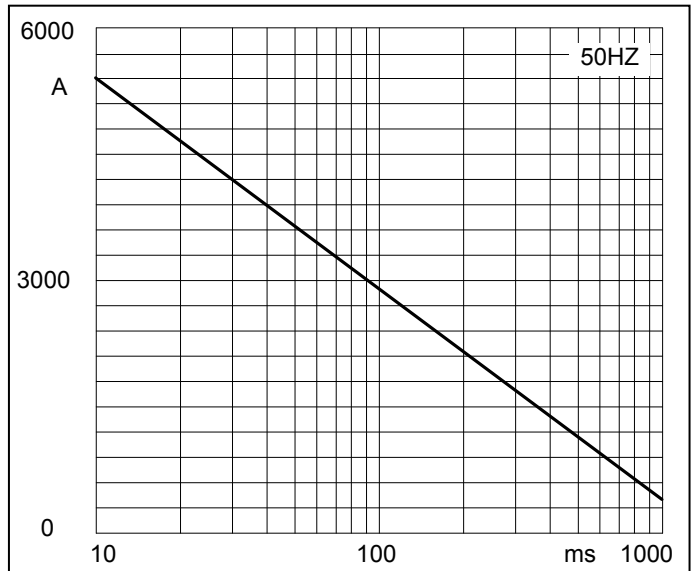


Fig4. Max Non-Repetitive Forward Surge Current

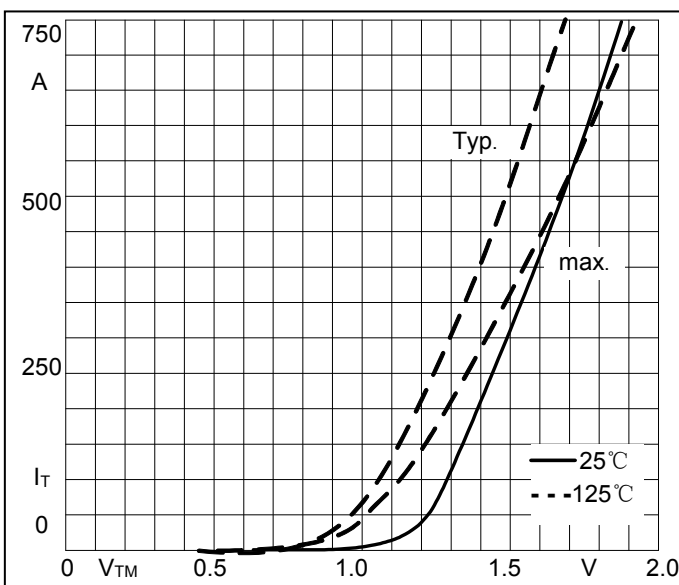


Fig5. Forward Characteristics

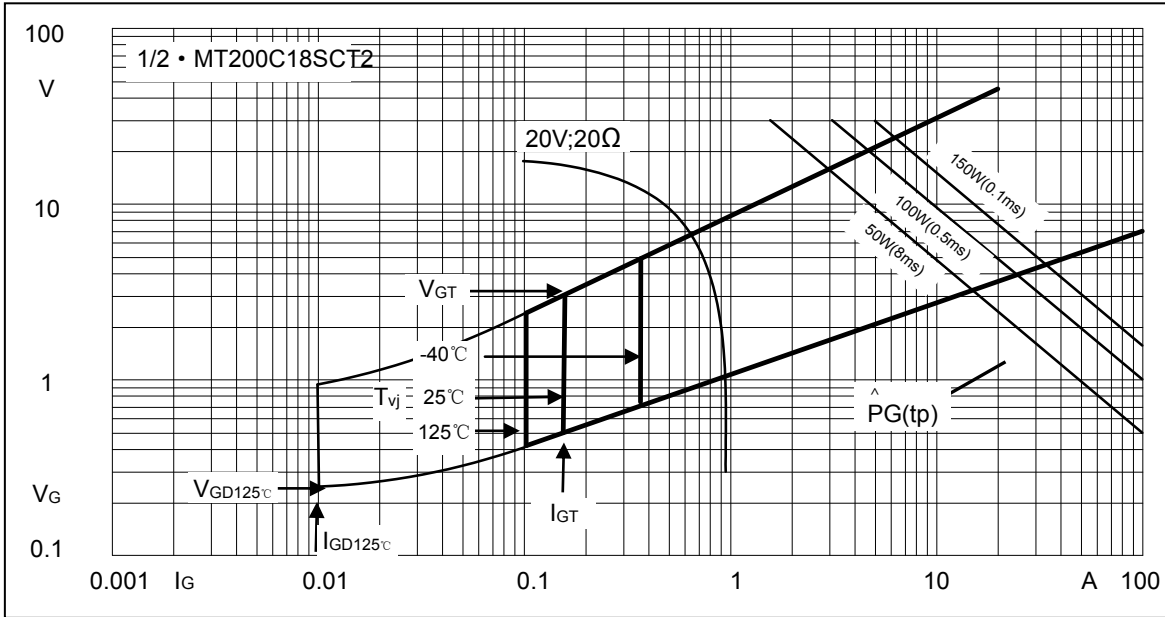
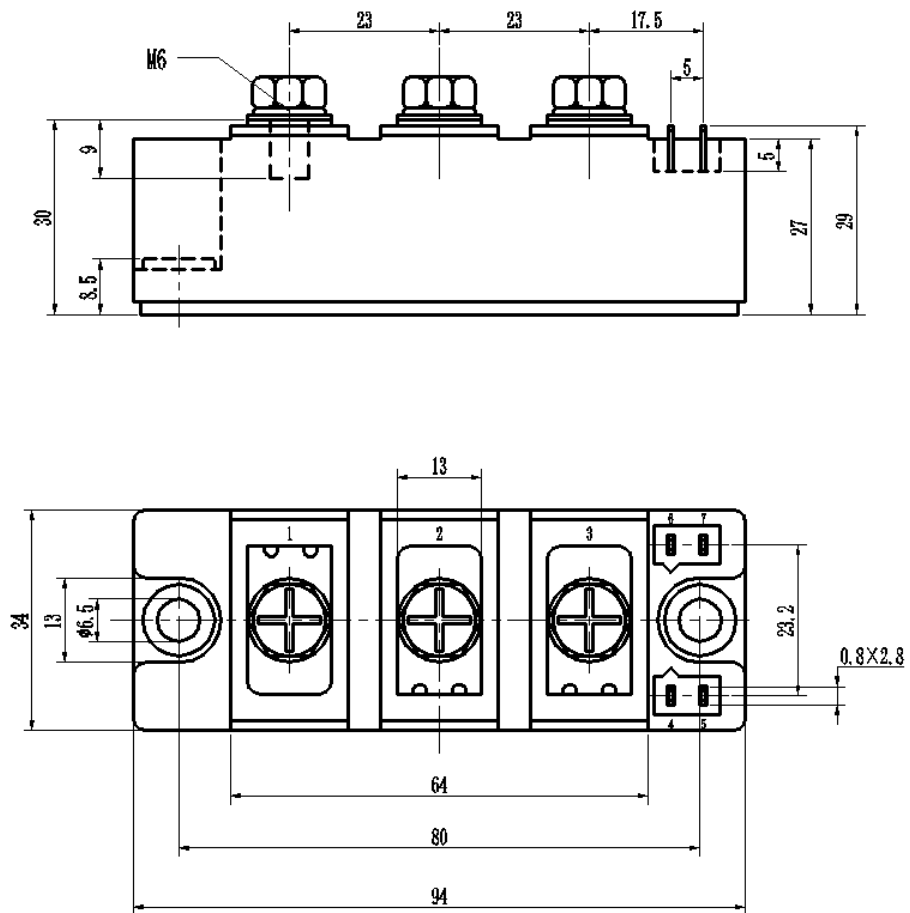


Fig6. Gate trigger Characteristics

Package Outline Information

CASE: T2



Dimensions in mm